



# **DCR4740Y18**

# **Phase Control Thyristor**

Replaces DS5971-3 DS5971-4 July 2023 (LN42667)

### **FEATURES**

- Double Side Cooling
- High Surge Capability

### **APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

### **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
DCR4740Y18	1800	$T_{vj} = -40 ^{\circ} C \text{ to } 125 ^{\circ} C,$ $IDRM = IRRM = 200 mA,$ $VDRM, VRRM t_p = 10 ms$ $VDSM \& VRSM =$ $VDRM \& VRRM + 100 V$ $respectively$

Lower voltage grades available.

### **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

### DCR4740Y18

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

### **KEY PARAMETERS**

$\mathbf{V}_{DRM}$	1800V
IT(AV)	4720A
Ітѕм	63100A
dV/dt*	2000V/μs
dl/dt	300A/μs

<sup>\*</sup> Higher dV/dt selections are available on request

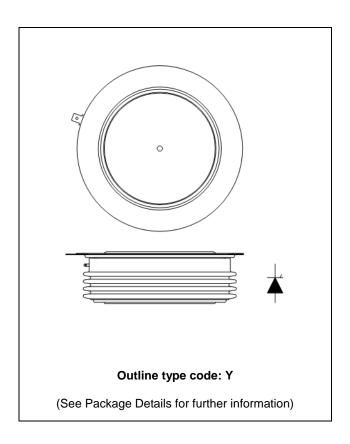


Fig. 1 Package outline

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# **CURRENT RATINGS**

# T<sub>case</sub> = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
İT(AV)	Mean on-state current	Half wave resistive load	4720	А
IT(RMS)	RMS value	-	7410	А
lτ	Continuous (direct) on-state current	-	6330	А

# **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 125°C	63.1	kA
l²t	I2t for fusing	V <sub>R</sub> = 0	19.9	MA <sup>2</sup> s

# THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Condition	Test Conditions		Max.	Units
	Double s		DC	-	8.4	°C/kW
Rth(j-c)	Thermal resistance - junction to case	Cingle side socied	Anode DC	-	13.4	°C/kW
		Single side cooled	Cathode DC	-	23.1	°C/kW
D	Clamping force 54kN  Thermal resistance - case to heatsink  (with mounting compound)		Double side	-	2.0	°C/kW
Rth(c-h)			Single side	-	4.0	°C/kW
Tvj	Virtual junction temperature	Blocking VDRM / VRRM		-	125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			48	59	kN

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# **DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Condition	ıs	Min.	Max.	Units
IRRM/IDRM	Peak reverse and off-state current	At VRRM/VDRM, Tcase = 125°C	;	-	200	mA
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		1.02	1.08	V
dV/dt	Max. linear rate of rise of off-state voltage	To 67% VDRM, Tj = 125°C, ga	ate open	-	2000	V/µs
dl/dt	Rate of rise of on-state current	From 67% V <sub>DRM</sub> to 2x I <sub>T(AV)</sub> Gate source 30V, 10Ω	Repetitive 50Hz	-	150	A/µs
di/dt	Rate of rise of on-state current	tr < 0.5µs, Tj = 125°C	Non-repetitive	-	300	A/µs
Vzza	Threshold voltage - Low level	500A to 3500A at Tcase = 125°C		-	0.71	V
<b>V</b> т(то)	Threshold voltage - High level 3500A to 8000A at Tcase = 125°C		-	0.85	V	
_	On-state slope resistance - Low level	500A to 3500A at Tcase = 125°C		-	0.10	mΩ
ľτ	On-state slope resistance - High level	3500A to 8000A at Tcase = 1	25°C	-	0.06	mΩ
tgd	Delay time	$V_D = 67\% \ V_{DRM}, \ gate \ source \ 30V, \ 10\Omega$ $t_T = 0.5 \mu s, \ T_j = 25 ^{\circ} C$		-	3	μs
tq	Turn-off time	$T_j = 125$ °C, $V_R = 200V$ , $dI/dt = 1A/\mu s$ , $dV_{DR}/dt = 20V/\mu s$ linear		-	250	μs
Qs	Stored charge	Iτ = 2000A, T <sub>j</sub> = 125°C, dI/dt = 1A/μs V <sub>R</sub> (peak) ~ 1100V, V <sub>RM</sub> ~ 720V		980	2090	μC
IRR	Reverse recovery current			23	35	А
lL	Latching current	Tj = 25°C, VD = 5V		-	3	А
Ін	Holding current	Tj = 25°C, Rg-κ = ∞, Iтм = 50	0A, Iτ = 5A	-	300	mA

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### **GATE TRIGGER CHARACTERISTICS AND RATINGS**

Symbol Parameter		Test Conditions	Max.	Units
<b>V</b> GT	Gate trigger voltage	VDRM = 5V, Tcase = 25°C	1.5	V
V <sub>GD</sub> Gate non-trigger voltage		At 50% VDRM, Tcase = 125°C	0.4	V
lgт	Gate trigger current	VDRM = 5V, Tcase = 25°C	250	mA
IGD	Gate non-trigger current	At 50% VDRM, Tcase = 125°C	10	mA

### **CURVES**

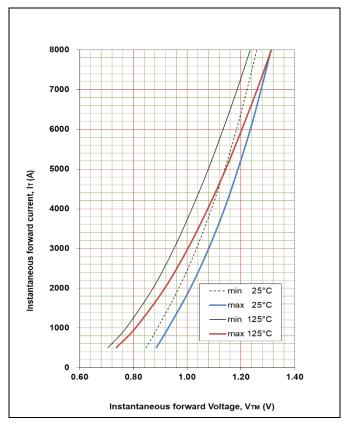


Fig. 2 Maximum & minimum on state characteristics

# **VTM EQUATION**

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$ 

Where A = 0.628851

B = -0.014195

C = 0.000005

D = 0.008621

These values are valid for  $T_j$  = 125°C for  $I_T$  500A to 8000A

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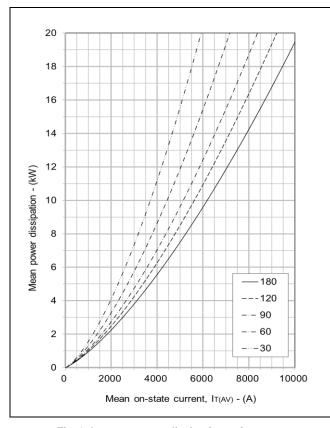


Fig. 3 On-state power dissipation - sine wave

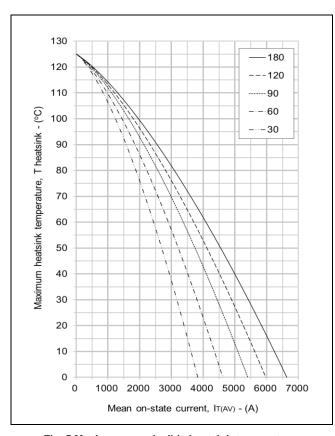


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

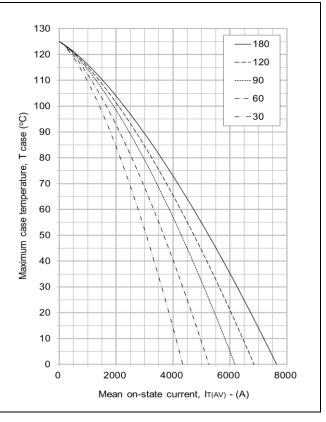


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

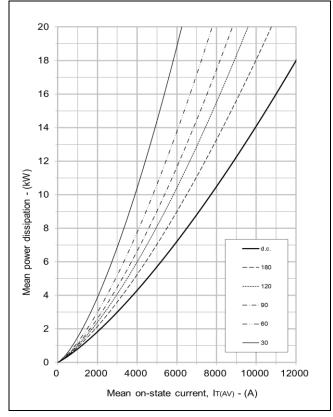


Fig. 6 On-state power dissipation - rectangular wave

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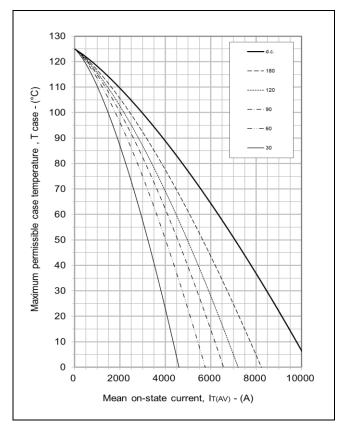
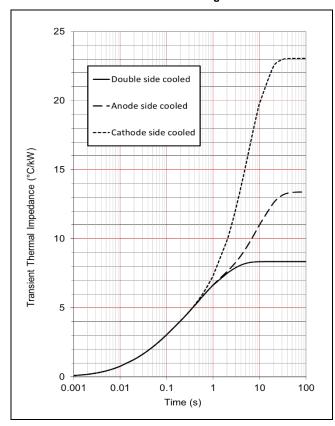


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



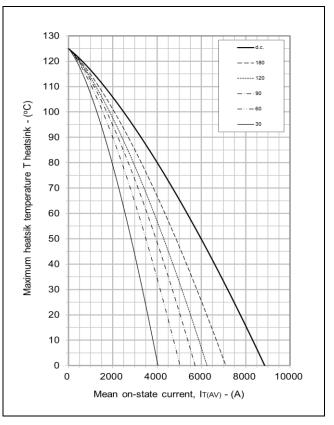


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	0.612	1.772	3.105	2.861
cooled	Ti(s)	0.010	0.056	0.333	1.632
Anode side	Ri(°C/kW)	0.701	1.939	3.610	7.138
cooled	Ti(s)	0.011	0.066	0.420	9.061
Cathode side	Ri(°C/kW)	0.673	2.017	1.731	18.639
cooled	Ti(s)	0.011	0.066	0.304	5.727

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{\text{th(j-c)}}$  Conduction

Tables show the increments of thermal resistance R  $_{\text{th(j-c)}}$  when the device operates at conduction angles other than d.c.

Double side cooling					
	$\Delta Z_{th}$	(Z)			
θ°	sine.	rect.			
180	0.94	0.65			
120	1.09	0.92			
90	1.24	1.07			
60	1.38	1.23			
30	1.49	1.40			
15	1.54	1 49			

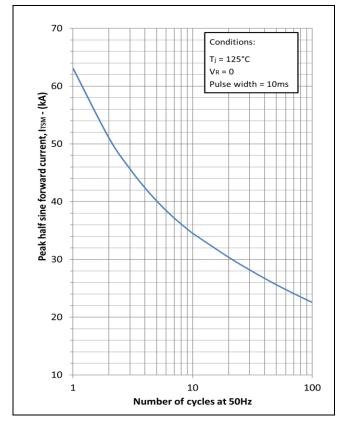
		Anode Side Cooling				Cath	ode Side	d Cooling
			$\Delta Z_{th}$ (Z)				$\Delta Z_t$	h (Z)
t.		θ°	sine.	rect.		θ°	sine.	rect.
5		180	0.94	0.64		180	0.94	0.64
2		120	1.08	0.91		120	1.08	0.91
7		90	1.23	1.06		90	1.24	1.06
3		60	1.37	1.22		60	1.37	1.22
0		30	1.47	1.38		30	1.48	1.39
a		15	1.50	1 /17		15	1.53	1 /19

Call	iode Side	ode Sided Cooling			
	$\Delta Z_t$	h (Z)			
θ°	sine.	rect.			
180	0.94	0.64			
120	1.08	0.91			
90	1.24	1.06			
60	1.37	1.22			
30	1.48	1.39			
15	1.52	1 /10			

Fig. 9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

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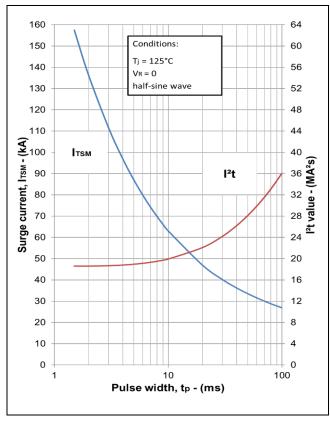


Fig. 10 Multi-cycle surge current

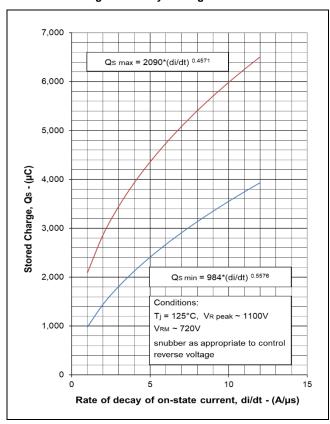


Fig. 12 Stored charge

Fig. 11 Single-cycle surge current

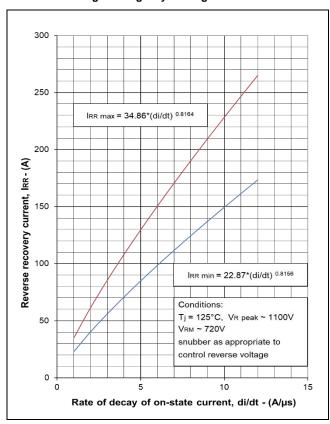


Fig. 13 Reverse recovery current

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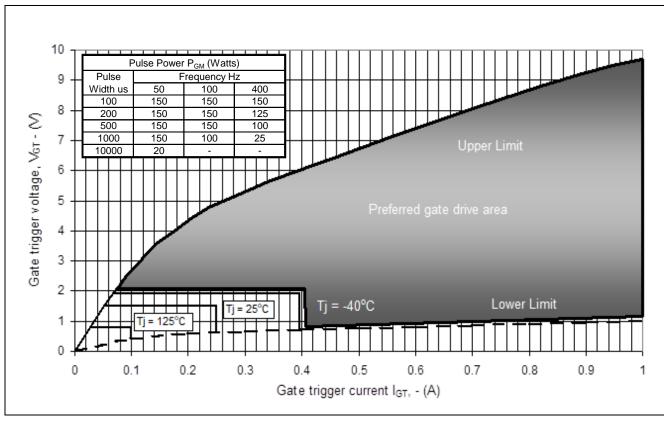


Fig. 14 Gate characteristics

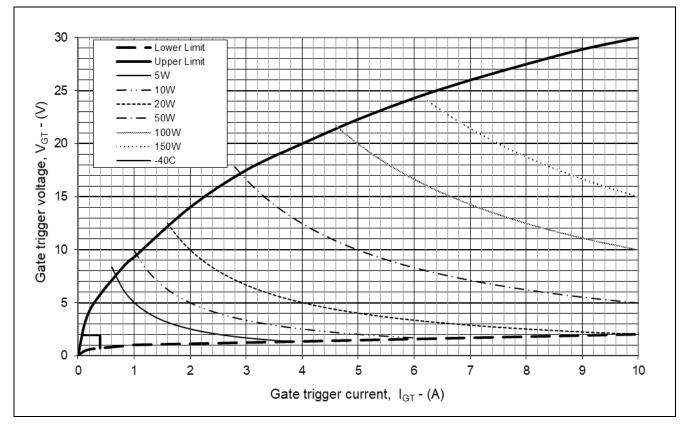


Fig. 15 Gate characteristics

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### **PACKAGE DETAILS**

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

### DO NOT SCALE

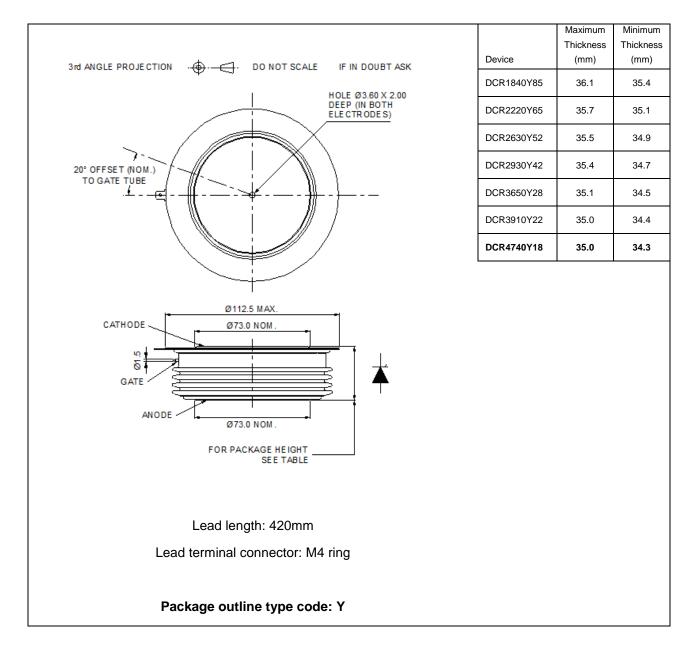


Fig. 16 Package outline

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# **HEADQUARTERS OPERATIONS**

DYNEX SEMICONDUCTOR LIMITED Doddington Road, Lincoln, Lincolnshire. LN6 3LF

United Kingdom.

Phone: +44 (0) 1522 500500

Web: http://www.dynexsemi.com

#### **CUSTOMER SERVICE**

Phone: +44 (0) 1522 502753 / 502901

e-mail: powersolutions@dynexsemi.com

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